

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
REQUEST FOR FILING APPLICATION UNDER 35 U.S.C. 1.53(b)
WITH FILING FEE OR EXECUTED INVENTOR'S OATH/DECLARATION

Assistant Commissioner for Patents
Washington, DC 20231

Atty. Dkt. 925-177

Date: February 7, 2001

Sir:



02/07/01

Jc971 U.S. PTO
09/778045
02/07/01

This is a request for filing a new PATENT APPLICATION under Rule 53(b) entitled:

SEMICONDUCTOR LIGHT-EMITTING DEVICE AND MANUFACTURING METHOD THEREFOR

without a filing fee and/or without an executed inventor's oath/declaration.

This application is made by the below identified inventor(s). Attached hereto are the following papers:

- ☒ An abstract together with
42 pages of specification and claims including
14 numbered claims and also attached is/are
24 sheets of accompanying drawings.
☒ This application is based on the following prior foreign application(s):

Application No.	Country
2000-029030	JAPAN
2000-372776	JAPAN

Filing Date
7 February 2000
7 December 2000

respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☐ This application is based on the following prior provisional application(s):

Application No.	Filing Date
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respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☒ Certified copy/ies of foreign applications attached.

This application is a ☐ continuation/☐ division/☐ continuation-in-part of application Serial No. , filed .
Please amend the specification by inserting before the first line: --This application is a ☐ continuation/☐ division/☐ continuation-in-part of application Serial No. , filed , the entire content of which is hereby incorporated by reference in this application.--

Please amend the specification by inserting before the first line: --This is a continuation of PCT application No. , filed , the entire content of which is hereby incorporated by reference in this application.--

Please amend the specification by inserting before the first line: --This application claims the benefit of U.S. Provisional Application No. , filed , the entire content of which is hereby incorporated by reference in this application.--

Preliminary amendment to claims (attached hereto), to be entered before calculation of the fee.

Also attached: ☒ Information Disclosure Statement ; ☐ Non-Publication Request; ☐ Other:

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☒ See attached sheet(s) for additional inventor(s) information!!

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